



MJ P-Channel Enhancement Mode Power MOSFET

Description

The MJ40P20Q uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, This device is suitable for use as a load switch or power management.

General Features

- V_{DS} =-40V,ID=-20A RDS(ON)<12mΩ @ VGS=-10V RDS(ON)<17mΩ @ VGS=-4.5V
- ◆ High Power and current handing capability
- ◆ Lead free product is acquired
- Surface mount package

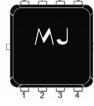
Application

- Power management
- Load switch

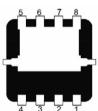
DFN 3.3X3.3

\$1 \$2 \$3 6D

Schematic Diagram







Bottom View

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

5 D

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity	
MJ40P20Q	MJ40P20Q	DFN3.3X3.3-8L				

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-20	А
Drain Current-Pulsed (Note 1)	IDM	-80	А
Maximum Power Dissipation	Po	30	W
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 150	°C

Thermal Characteristic

(1) (2)			
Thermal Resistance, Junction-to-Case (Note 2)	RθJA	4.17	°C/W





Electrical Characteristics (T_A =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics	'		'			
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250µA	-40	-	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =-40V,V _{GS} =0V	_	-	-1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	_	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	Vos=Vgs ,Io=-250µA	-1.2	-1.8	-2.4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	14	18	mΩ
	RDS(ON)	V _{GS} =-4.5V, I _D =-20A	-	21.5	28	mΩ
Forward Transconductance	grs	V _{DS} =-10V,I _D =-20A	-	25	-	S
Dynamic Characteristics (Note 4)		ı			ı	
Input Capacitance	Clss	V _{DS} =-20V,V _{GS} =0V, F=1.0MHz	-	2000	-	PF
Output Capacitance	Coss		-	300	-	PF
Reverse Transfer Capacitance	Crss		-	275	-	PF
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	VDD=-20V, ID=-20A,	-	9.4	-	nS
Turn-Off Delay Time	t _{d(off)}	V _B D20V, ID20A, V _G S=-10V,R _G EN=3Ω	-	24	-	nS
Turn-Off Fall Time	t f	•	-	12	-	nS
Total Gate Charge	Qg		-	31	-	nC
Gate-Source Charge	Qgs	V _{DS} =-20V,I _D =-20A, V _{GS} =-10V	-	5.5	-	nC
Gate-Drain Charge	Q _{gd}		-	6.5	-	nC
Drain-Source Diode Characteristics	I	I	1	1	1	
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =-20A	_	_	-1.2	V

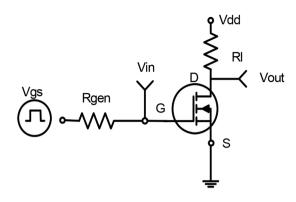
Notes

- 1) Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- ③ Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production





Typical Electrical and Thermal Characteristics



 $t_{d(on)}$ $t_{d(off)}$ t_{d

Figure 1 Switching Test Circuit

Figure 2 Switching Waveforms

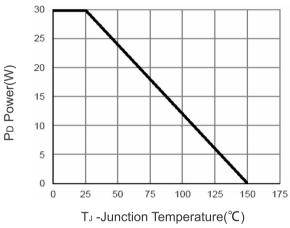


Figure 3 Power Dissipation

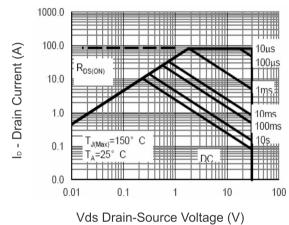


Figure 4 Safe Operation Area

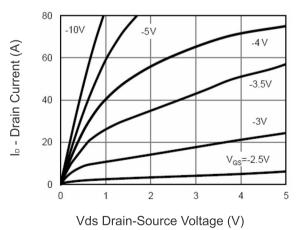


Figure 5 Output Characteristics

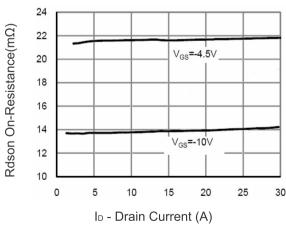
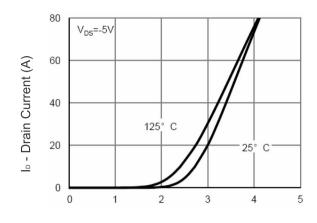


Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V) Figure 7 Transfer Characteristics

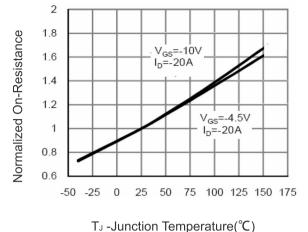


Figure 8 Drain-Source On-Resistance

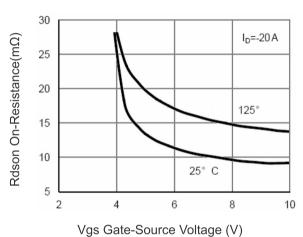


Figure 9 Rdson vs Vgs

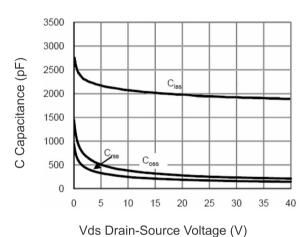


Figure 10 Capacitance vs Vds

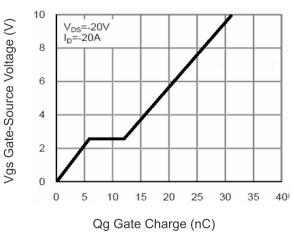


Figure 11 Gate Charge

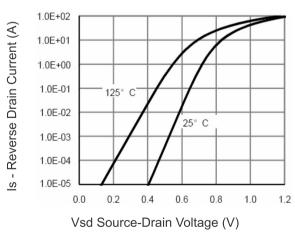


Figure 12 Source- Drain Diode Forward



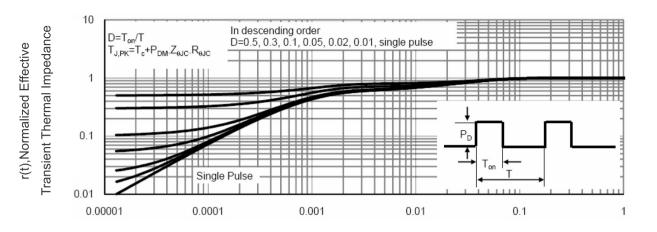


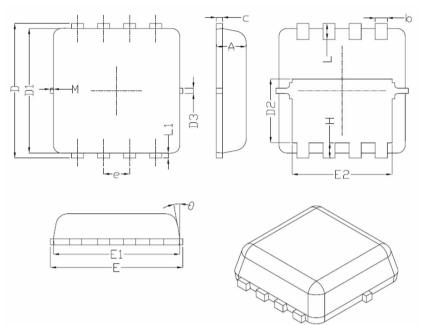
Figure 14 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



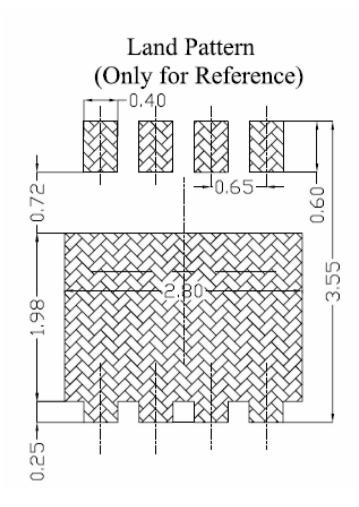


DFN3.3X3.3-8L Package Information



		~			
Sameh al	Dimensions In Millimeters				
Symbol	Min.	Nom.	Max.		
А	0.70	0.75	0.80		
b	0.25	0.30	0.35		
С	0.10	0.15	0.25		
D	3.25	3.35	3.45		
D1	3.00	3.10	3.20		
D2	1.48	1.58	1.68		
D3	-	0.13	-		
Е	3.20	3.30	3.40		
E1	3.00	3.15	3.20		
E2	2.39	2.49	2.59		
е	0.65BSC				
Н	0.30	0.39	0.50		
L	0.30	0.40	0.50		
L1	-	0.13	-		
М	*	*	0.15		
θ		10°	12 [°]		









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